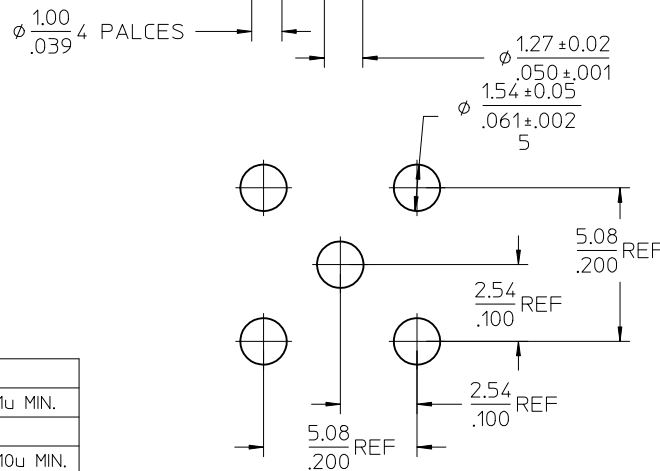
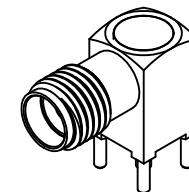
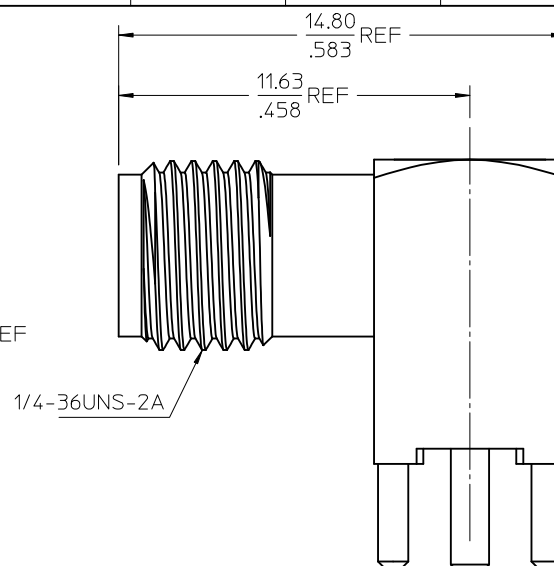
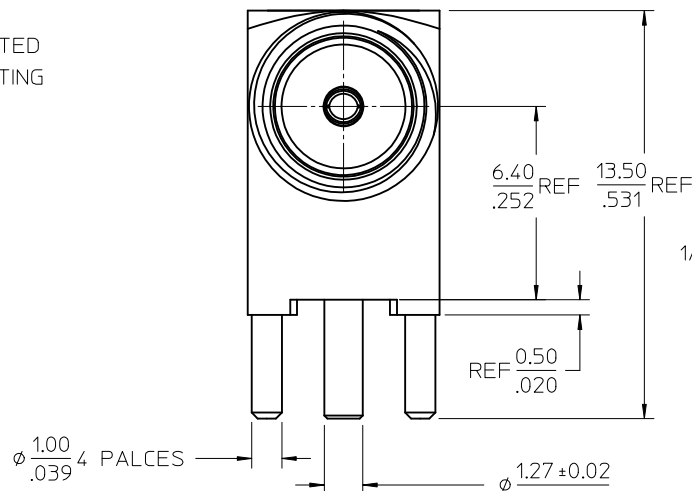
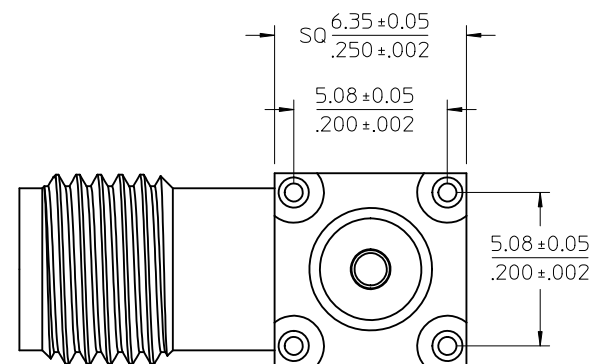


MATERIAL&FINISH;
1)BODY:ZINC ALLOY / SEE TABLE FOR PLATING
2)INSULATOR:TEFLON
3)FEMALE CENTER CONTACT:
BERYLLIUM COPPER / GOLD PLATED
4)CENTER CONTACT :BRASS/GOLD PLATED
5)COVER:BRASS/ SEE TABLE FOR PLATING

PACKING :BY TRAY



RECOMMEND PCB DIMENSION
(BOTTOM VIEW)



3	73391-0083	COVER, GOLD 1u MIN. BODY AND PIN, GOLD 1u MIN.
2	73391-0081	COVER, GOLD 10u MIN. BODY AND PIN, GOLD 10u MIN.
1	73391-0080	COVER, NICKEL PLATED BODY, NICKEL PLATED
	PART NO.	DESCRIPTION

PS-73598-0111	SPECIFICATION
MIL-STD-348A, FIG. 310.1	SMA INTERFACE
SPECIFICATION	DESCRIPTION

73391-0082		73391-0080 BY TRAY (20 CAV.)					
PART NO.		PACKAGING					
Y S	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM/IN		SCALE	DESIGN UNITS METRIC	 THIRD ANGLE PROJECTION
	mm INCH		DRAWN BY LYNN LIN DATE 1998/12/08		TITLE 50 OHM SMA R/A PCB RECEPTACLE SMA-J/RA  MOLEX INCORPORATED		
	4 PLACES ± --- ± ---		CHECKED BY A. CLARY DATE 1998/12/08				
	3 PLACES ± --- ± ---		APPROVED BY NISEN DATE 1998/12/08				
	2 PLACES ± --- ± ---						
	1 PLACE ± --- ± ---						
	ANGULAR ± 2 °						
	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		MATERIAL NO. SEE TABLE		DOCUMENT NO. SD-73391-008		SHEET NO. 1 OF 1
SIZE C		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION					

ADDED P/N73391-0083 RTM PDR1008650 EC NO: URF2011-0120 DRWN:LIN CHKD: APPR:MHUANG REV	2010/08/23 2010/09/02 2010/09/02	DESCRIPTION	QUALITY SYMBOLS =0 =0
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